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#### FOR IMMEDIATE RELEASE

# Emerson & Cuming Microwave Products, a Unit of Laird Technologies to Attend European Microwave Week 2012

Company Will Showcase ECCOSORB® and ECCOSTOCK® products

St. Louis, Missouri, USA – October 16, 2012 – Laird Technologies, Inc., a global leader in the design and supply of customized performance-critical components and systems for advanced electronics and wireless products, today announced it will be attending European Microwave Week in Amsterdam. The company will participate in the exhibition portion of the event October 29-31, 2012. Laird Technologies will exhibit at booth #225.

Emerson & Cuming Microwave Products, a unit of Laird Technologies will be displaying samples from their ECCOSORB® microwave absorbers and ECCOSTOCK® dielectric materials. The company will also be highlighting their <u>injection molded absorbers</u>. These absorbers can be attached without the use of glue and offer shrinkage less than .5%. Benefits include a shorter production cycle and a lower total cost.

"Attending European Microwave Week provides us an opportunity to promote our company and products to an audience dedicated to the microwave business," said Gust Timmerman, Laird Technologies Global Product Director EMI Microwave Absorbers. "Our ECCOSORB® and ECCOSTOCK® products offer many benefits and EUMW is an excellent platform to showcase our abilities to new and existing customers."

As an industry-leading EMI solutions provider, Laird Technologies has a complete portfolio of standard and customized EMI products for industries around the world. The addition of the Emerson & Cuming Microwave Products enhances Laird Technologies EMI solutions product offerings. For more information, white papers are available on the <a href="Theory and Application of RF/Microwave Absorbers">Theory and Application and Theory of Dielectric Materials in RF/Microwave Systems</a>.

European Microwave Week is the largest European tradeshow dedicated to Microwaves and RF. The schedule includes exhibitor workshops, seminars and round table forums. The event brings together leading manufacturers, institutes and industry leaders to discuss cutting edge developments in Microwaves, RF, Wireless, Defense/Security and Radar.

Emerson & Cuming Microwave Products, a unit of Laird Technologies, is a global leader in the development and manufacture of microwave absorbing materials, low-loss dielectrics and electrically conductive shielding materials combining that absorber technology with a wide range of capabilities, in-depth knowledge of materials science, chemistry, microwave theory, and measurement techniques coupled with modern R&D laboratories, to offer high quality leading edge products and customized solutions. To learn more, visit the Emerson & Cuming Microwave Products, a unit of Laird Technologies booth or visit us at <a href="https://www.eccosorb.eu">www.eccosorb.eu</a> and <a href="https://www.eccosorb.eu">www.eccos

## About Laird Technologies, Inc.

Laird Technologies is a global technology company focused on providing components and solutions that protect electronic devices from electromagnetic interference and heat, and that enable connectivity through wireless applications and antenna systems.

Custom products are supplied to all sectors of the electronics industry including the handset, telecommunications, data transfer and information technology, automotive, aerospace, defense, consumer, medical, mining, railroad and industrial markets.

Laird Technologies, a unit of Laird PLC, employs over 9,000 employees in more than 46 facilities located in 16 countries.

## **Contact Information**

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#### **Translations**

Translated versions of this press release are available in Simplified and Traditional Chinese, Japanese, Korean, and German languages.

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